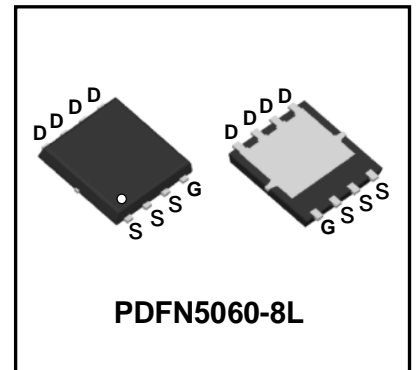


60V N-Channel Enhancement Mode Power MOSFET

Description

WMB082N06LG2 uses Wayon's 2nd generation power trench MOSFET technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance. This device is well suited for high efficiency fast switching applications.



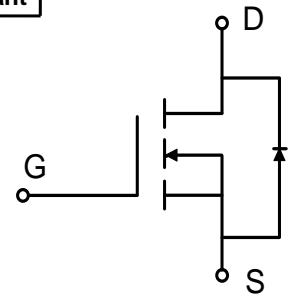
Features

- $V_{DS} = 60V$, $I_D = 52A$
 $R_{DS(on)} < 8.2m\Omega @ V_{GS} = 10V$
 $R_{DS(on)} < 12m\Omega @ V_{GS} = 4.5V$
- Green Device Available
- 100% EAS Guaranteed
- Low $R_{DS(on)}$



Applications

- Industrial and Motor Drive Application
- DC/DC Converters
- Power Management Functions



Absolute Maximum Ratings

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	60	V
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current ¹	$T_C=25^\circ C$	I_D	52	A
	$T_C=100^\circ C$		34	
Pulsed Drain Current ²		I_{DM}	160	A
Single Pulse Avalanche Energy ³		EAS	196	mJ
Avalanche Current		I_{AS}	28	A
Total Power Dissipation ⁴	$T_C=25^\circ C$	P_D	42	W
	$T_C=100^\circ C$		18	
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Case ¹	$R_{\theta JC}$	3	$^\circ C/W$

Electrical Characteristics $T_c = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static Characteristics							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	60	-	-	V	
Gate-body Leakage Current	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	± 100	nA	
Zero Gate Voltage Drain Current	$T_J=25^\circ\text{C}$	I_{DSS}	$V_{DS} = 60V, V_{GS} = 0V$	-	-	1	μA
	$T_J=55^\circ\text{C}$			-	-	5	
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.2	1.7	2.5	V	
Drain-Source On-Resistance ²	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 20A$	-	5.9	8.2	m Ω	
		$V_{GS} = 4.5V, I_D = 10A$		7.7	12		
Dynamic Characteristics							
Input Capacitance	C_{iss}	$V_{DS} = 30V, V_{GS} = 0V, f = 1\text{MHz}$	-	1935	-	pF	
Output Capacitance	C_{oss}		-	455	-		
Reverse Transfer Capacitance	C_{rss}		-	13.5	-		
Switching Characteristics							
Gate Resistance	R_G	$V_{DS} = 0V, V_{GS} = 0V, f = 1\text{MHz}$	-	1.6	-	Ω	
Total Gate Charge	Q_g	$V_{GS} = 10V, V_{DD} = 30V, I_D = 20A$	-	30	-	nC	
Gate-Source Charge	Q_{gs}		-	5.8	-		
Gate-Drain Charge	Q_{gd}		-	5.9	-		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 10V, V_{DD} = 30V, R_G = 3\Omega, R_L = 2.5\Omega$	-	9.7	-	nS	
Rise Time	t_r		-	4.8	-		
Turn-Off Delay Time	$t_{d(off)}$		-	29	-		
Fall Time	t_f		-	7.8	-		
Drain-Source Body Diode Characteristics							
Diode Forward Voltage ²	V_{SD}	$I_S = 20A, V_{GS} = 0V$	-	-	1.2	V	
Reverse Recovery Time	t_{rr}	$I_F = 20A, di_F/dt = 500A/\mu s$	-	58	-	ns	
Reverse Recovery Charge	Q_{rr}		-	17	-	nC	

Notes:

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. The EAS data shows Max. rating. The test condition is $V_{DD}=30V, V_{GS}=10V, L=0.5mH, I_{AS}=28A, R_G=25\Omega$
4. The power dissipation is limited by 150°C junction temperature

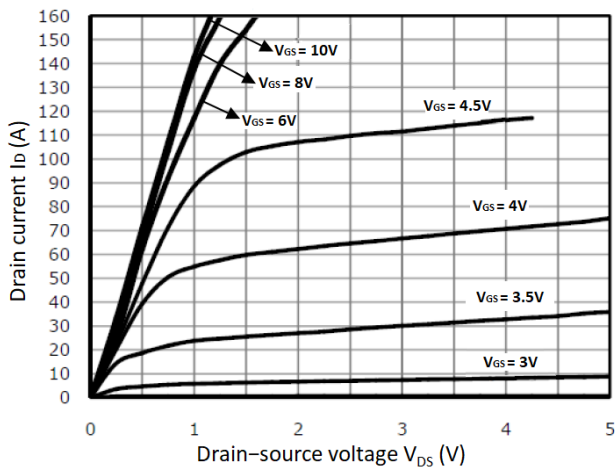


Figure 1. Output Characteristics

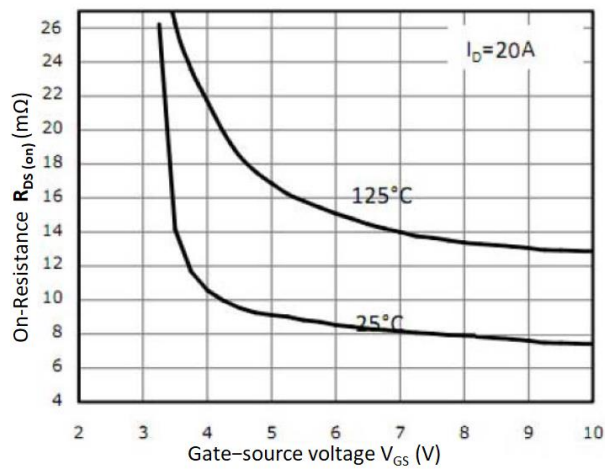


Figure 2. $R_{DS(on)}$ vs. V_{GS}

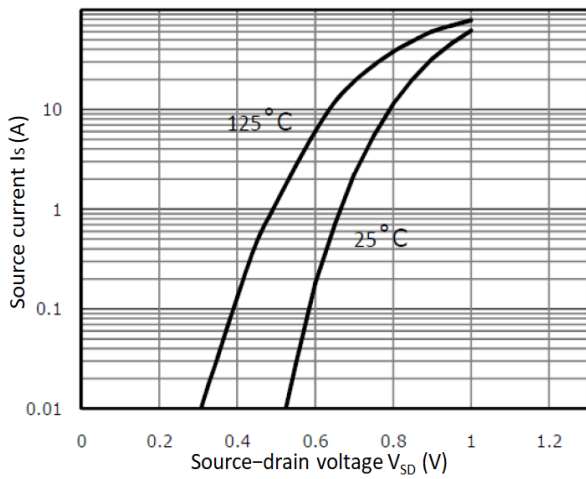


Figure3. Forward Characteristics of Reverse

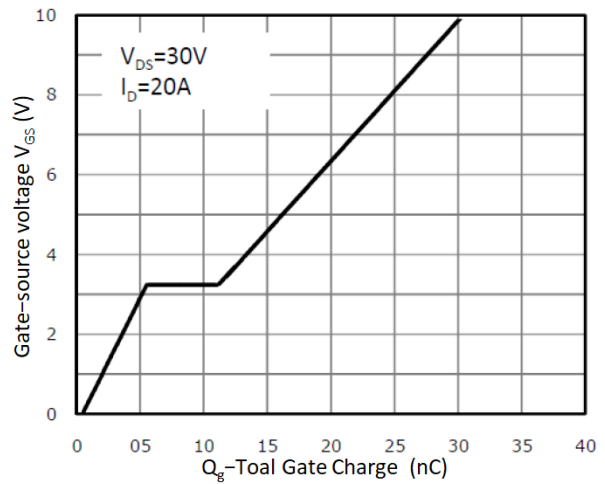


Figure4. Gate Charge Characteristics

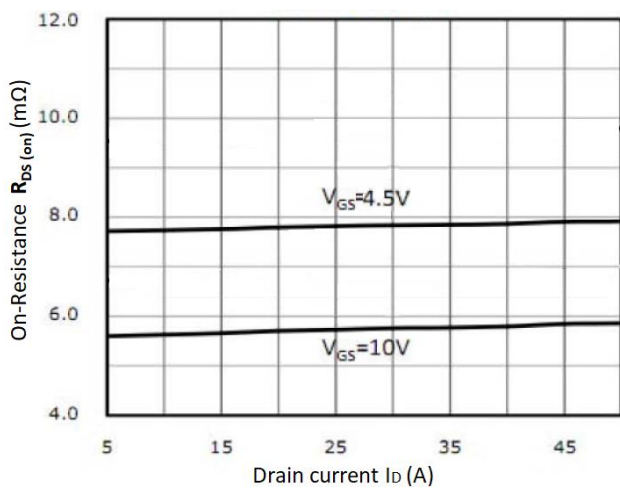


Figure 5. $R_{DS(ON)}$ Vs I_D

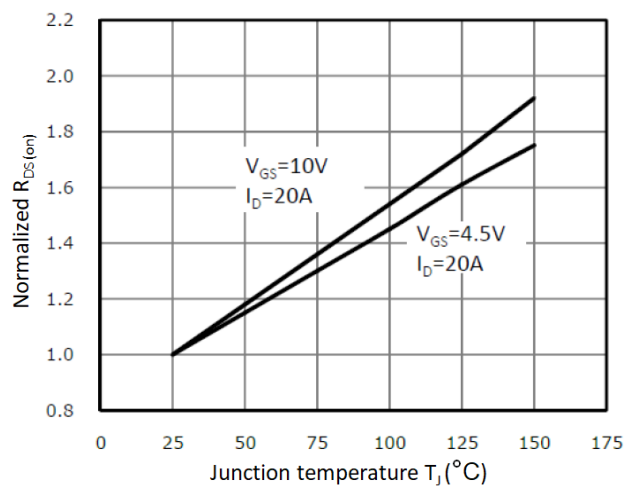


Figure 6. Normalized $R_{DS(on)}$ vs. T_J

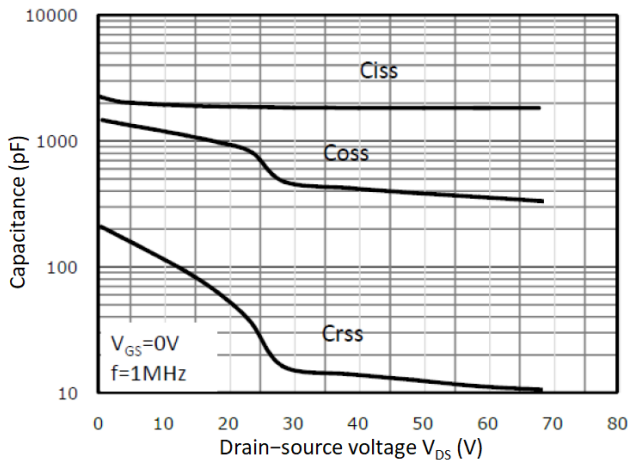


Figure 7. Capacitance Characteristics

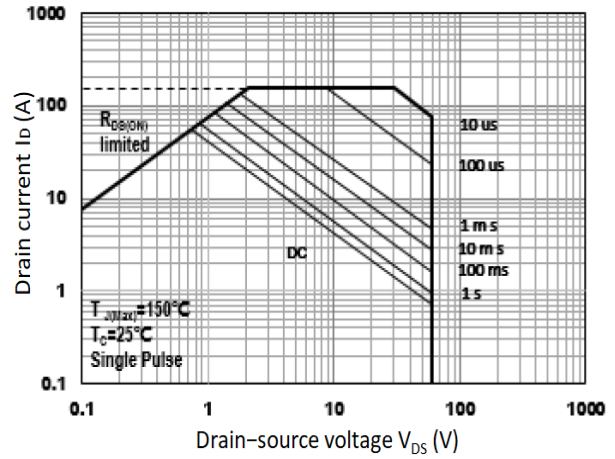


Figure 8. Safe Operating Area

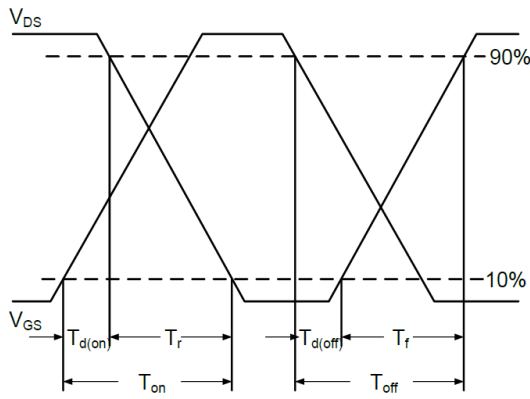


Figure 9. Switching Time Waveform

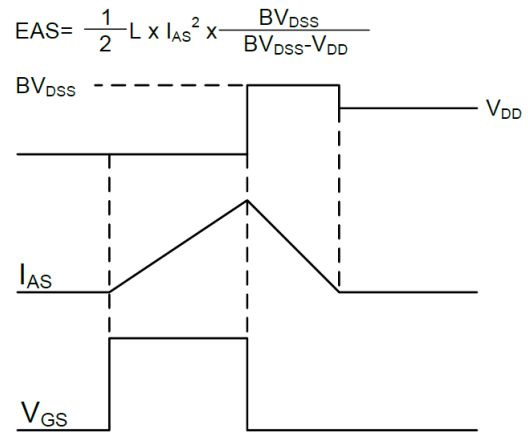
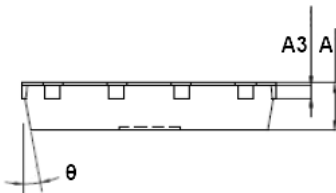
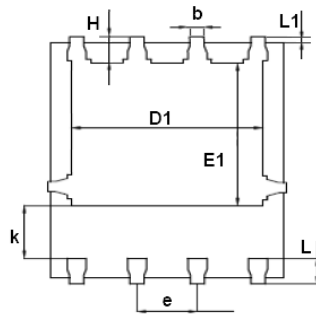
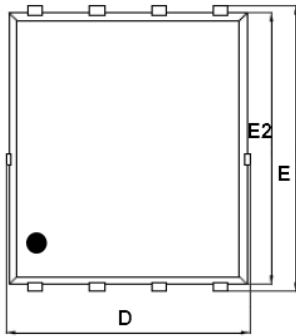


Figure 10. Unclamped Inductive Switching Waveform

Mechanical Dimensions for PDFN5060-8L

COMMON DIMENSIONS

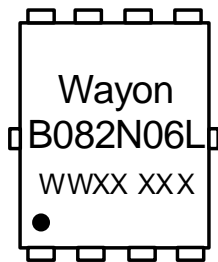


SYMBOL	MM	
	MIN	MAX
A	0.90	1.17
A3	0.20	0.35
D	4.80	5.40
E	5.90	6.15
D1	3.61	4.31
E1	3.30	3.78
E2	5.65	5.85
k	1.10	-
b	0.30	0.51
e	1.27BSC	
L	0.38	0.71
L1	0.05	0.36
H	0.38	0.61
θ	0°	12°

Ordering Information

Part	Package	Marking	Packing method
WMB082N06LG2	PDFN5060-8L	B082N06L	Tape and Reel

Marking Information



B082N06L = Device code

WWXX XXX= Date code

Contact Information

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